	100GKE	TITLE	INVENTORS	* AMOUNT US\$	PARENT NO
1	ZE017	Printhead assembly incorporating one or more printhead modules	Kia Silverbrook, Tobin Allen King	850.00	ART108
2	ZE018	Printhead assembly incorporating a channel member	Kia Silverbrook, Tobin Allen King	850.00	ART108
3	ZE019	Printhead assembly incorporating an elastomeric feed member	Kia Silverbrook, Tobin Allen King	850.00	ART108
4	ZE020	Printhead assembly incorporating micromoldings	Kia Silverbrook, Tobin Allen King	850.00	ART108
5	BAL70	A camera for printing manipulated images	Kia Silverbrook, Paul Lapstun, Simon Robert	998.00	ART51
6	BAL71	A camera for pimting on media provided on print roll	Walmslev Kia Silverbrook, Paul Lapstun, Simon Robert Walmslev	1,142.00	ART51
7	BAL72	A camera for printing manipulated images on media	Kia Silverbrook, Paul Lapstun, Simon Robert	1,070.00	
8	BAL73	A camera and controlling processing system	Walmslev Kia Silverbrook, Paul Lapstun, Simon Robert	1,070.00	ART51 ART51
9	ZE009	A method of fabricating a fluid ejection device using a planarizing step	Walmslev Kia Silverbrook	810.00	
10	ZE010	A micro-electromechanical fluid ejection device with control logic circuitry	Kia Silverbrook		1J46 Div. 2
11	ZE011	A printhead configuration incorporating a nozzle arrangement layout	Kia Silverbrook	810.00	IJ46 Div. 2
12	ZE012	A method of fabricating a micro-electromechanical device having a laminated actuator	Kia Silverbrook	810.00	IJ46 Div. 2
13	ZF189	An image capture and processing device for a print on demand digital camera system	Kia Silverbrook	810.00	IJ46 Div. 2
14	ZF190	A printhead assembly for a print on demand digital camera system	Kia Silverbrook	810.00	IR18
15	ZF191	A printhead re-capping assembly for a print on demand digital camera system	Kia Silverbrook	810.00	IR18
16	MTB05	Ink Jet printhead with circular cross section chamber	Kia Silverbrook	1,044.00	IR18
17	MTB07	Ink jet printhead with amorphous ceramic chamber	Kia Silverbrook		MJ40
18	ZF132	Composite support beam for pirnthead assembly	Kia Silverbrook	1,116.00	MJ40
19	ZF133	Thermal expansion relief for printhead assembly	Kia Silverbrook	810.00	MJ44
20	ZF134	Thermal expansion compensation for printhead assembly	Kia Silverbrook	810.00	MJ44
21	ZE013	A micro-electromechanical fluid ejection device having a chamber that is volumetrically altered for fluid ejection	Kia Silverbrook	810.00	MJ44
22	ZF014	A micro-electromechanical fluid ejection device having a nozzle guard	Kia Silverbrook	810.00	MJ95
23	MTB01	Thermal ink jet printhead with short heater to nozzle aperture distance	Kia Silverbrook	810.00	MJ95
24	MTB012	Thermal ink jet printhead with low resistance electrodes for heaters	Kia Silverbrook	1,422.00	MJT001
25	MTB013	Thermal ink jet printhead with heater elements supported by electrodes	Kia Silverbrook	1,422.00	MJT001
				1,422.00	MJT001

26	MTB02	Very high efficiency thermal ink let printheed	Kia Silverbrook, Angust		 .
20	IVITBUZ	Very high efficiency thermal ink jet printhead	John North, Gregory John McAvov	1,502.00	MJT001
27	МТВ03	Low voltage thermal ink jet printhead	Kia Silverbrook	1,422.00	MJT001
28	MTB04	Inkjet printhead with low mass displacement nozzle	Kia Silverbrook	1,422.00	MJT001
29	MTB06	Thermal ink jet printhead with bubble collapse point close to nozzle aperture	Kia Silverbrook	1,422.00	MJT001
30	MTB14	Heat dissipation within thermal ink jet printhead	Kia Silverbrook	1,422.00	MJT001
31	ZF184	Ink Distribution assembly	Kia Silverbrook	810.00	PAK12
32	ZG185	Printhead chassis assembly	Kia Silverbrook	810.00	PAK12
33	ZG186	Laminated distribution structure	Kia Silverbrook	810.00	PAK12
34	ZG112	Chips with wafer scale caps formed by molding	Kia Silverbrook	810.00	WSM01
35	ZG113	Two part mold for wafer scale caps	Kia Silverbrook	810.00	WSM01
36	ZG114	Wafer scale caps located by molding	Kia Silverbrook	810.00	WSM01
37	ZG115	Molded wafer scale cap array	Kia Silverbrook	810.00	WSM01
38	ZG116	Placement tool for wafer scale caps	Kia Silverbrook	810.00	WSM01
39	ZG117	Mold making method for wafer scale caps	Kia Silverbrook	810.00	WSM01
40	ZG118	Chip with molded cap array	Kia Silverbrook	810.00	WSM01
41	ZG119	Molded wafer scale cap	Kia Silverbrook	810.00	WSM01
42	ZF117	Thermoelastic inkjet actuator with heat conductive pathways	Kia Silverbrook, Gregory John McAvoy	850.00	YU185
43	22003	mechanisms located about ejection ports	Kia Silverbrook, Gregory John McAvoy	850.00	YU195
44	22000	A method of fabricating an ink jet printhead chip having actuator mechanisms located about ejection ports	Kia Silverbrook, Gregory John McAvoy	850.00	YU195
45			Kia Silverbrook, Gregory John McAvoy	850.00	YU195
46		l	Kia Silverbrook, Gregory John McAvoy	850.00	YU195
47		Page binder with air cushion and non-contact adhesive applicator	Kia Silverbrook	850.00	ZF107
48		Page binder with adhesive applicator for gluing traling edge of pages	Kia Silverbrook	850.00	ZF107
49	ZG189	Page binder with two part adhesive applicator	Kia Silverbrook	850.00	ZF107
50		Inkjet printhead with ink supply passage to nozzle etched from opposing sides of wafer	Kia Silverbrook		

51	МТВ09	Inkjet printhead with non-uniform width ink supply passage to nozzle	Kia Silverbrook	1,112.00	ZF121
52	МТВ10	Inkjet printhead with ink chamber inlet etched into wafer	Kia Silverbrook	1,256.00	ZF121
53	MTB11	Inkjet printhead with ink supply passage formed from both sides of the wafer by overlapping etches	Kia Silverbrook	1,256.00	ZF121
56					
57				51,520.00	

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